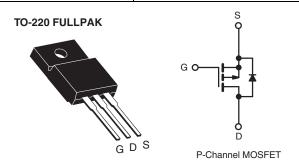


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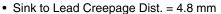
### **Power MOSFET**

PRODUCT SUMMARY			
V <sub>DS</sub> (V)	- 100		
$R_{DS(on)}\left(\Omega\right)$	V <sub>GS</sub> = - 10 V	0.20	
Q <sub>g</sub> (Max.) (nC)	61		
Q <sub>gs</sub> (nC)	14		
Q <sub>gd</sub> (nC)	29		
Configuration	Single		



#### **FEATURES**

- · Isolated Package
- High Voltage Isolation = 2.5 kV<sub>RMS</sub> (t = 60 s; f = 60 Hz)





- P-Channel
- 175 °C Operating Temperature
- Dynamic dV/dt
- · Low Thermal Resistance
- Lead (Pb)-free Available

#### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 FULLPAK eliminates the need for additional insulating hardware in commercial-industrial applications. The molding compound used provides a high isolation capability and a low thermal resistance between the tab and external heatsink. This isolation is equivalent to using a 100 micron mica barrier with standard TO-220 product. The FULLPAK is mounted to a heatsink using a single clip or by a single screw fixing.

ORDERING INFORMATION			
Package	TO-220 FULLPAK		
Lead (Pb)-free	IRFI9540GPbF		
Lead (Fb)-liee	SiHFI9540G-E3		
SnPb	IRFI9540G		
OIII D	SiHFI9540G		

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			$V_{DS}$	- 100	V	
Gate-Source Voltage			$V_{GS}$	± 20		
Continuous Drain Current	V <sub>GS</sub> at - 10 V	T <sub>C</sub> = 25 °C	1_	- 11	А	
		T <sub>C</sub> = 100 °C	I <sub>D</sub>	- 7.6		
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	- 44		
Linear Derating Factor				0.32	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	600	mJ	
Repetitive Avalanche Currenta			I <sub>AR</sub>	- 11	Α	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	4.8	mJ	
Maximum Power Dissipation	T <sub>C</sub> = 25 °C		$P_{D}$	48	W	
Peak Diode Recovery dV/dtc			dV/dt	- 5.5	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	°C	
Soldering Recommendations (Peak Temperature)	for 10 s			300 <sup>d</sup>	1	
Mounting Torque	6 22 or N	6-32 or M3 screw		10	lbf ⋅ in	
	0-32 01 1			1.1	N·m	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD} = -25 \text{ V}$ , starting  $T_J = 25 \,^{\circ}\text{C}$ ,  $L = 7.4 \,^{\circ}\text{mH}$ ,  $R_G = 25 \,^{\circ}\Omega$ ,  $I_{AS} = -11 \,^{\circ}\text{A}$  (see fig. 12).
- c.  $I_{SD} \le$  19 A,  $dI/dt \le$  170 A/ $\mu$ s,  $V_{DD} \le V_{DS}$ ,  $T_J \le$  175 °C.
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply

# **IRFI9540G**, SiHFI9540G

# Vishay Siliconix



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	65	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	3.1	C/VV	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	- 100	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	-	- 0.087	-	V/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = - 250 μA		-	- 4.0	٧
Gate-Source Leakage	I <sub>GSS</sub>	,	V <sub>GS</sub> = ± 20 V		-	± 100	nA
Zara Cata Valtana Daria Carrent		V <sub>DS</sub> =	V <sub>DS</sub> = - 100 V, V <sub>GS</sub> = 0 V		-	- 100	,
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = - 80 V	', V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C	-	-	- 500	μΑ
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 10 V	I <sub>D</sub> = - 6.6 A <sup>b</sup>	-	-	0.20	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	V <sub>DS</sub> = - 50 V, I <sub>D</sub> = - 6.6 A <sup>b</sup>		-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 \text{ V},$ $V_{DS} = -25 \text{ V},$ f = 1.0  MHz,  see fig. 5		-	1400	-	pF
Output Capacitance	C <sub>oss</sub>			-	590	-	
Reverse Transfer Capacitance	C <sub>rss</sub>			-	140	-	
Drain to Sink Capacitance	С		f = 1 MHz	-	12	-	
Total Gate Charge	Qg		I <sub>D</sub> = - 19 A, V <sub>DS</sub> = - 80 V, see fig. 6 and 13 <sup>b</sup>	-	-	61	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = - 10 V		-	-	14	
Gate-Drain Charge	Q <sub>gd</sub>	1		-	-	29	
Turn-On Delay Time	t <sub>d(on)</sub>				24	-	ns
Rise Time	t <sub>r</sub>	$V_{DD} = -50 \text{ V}, I_D = -19 \text{ A}, \\ R_G = 9.1 \Omega, R_D = 7.4 \Omega, \\ \text{see fig. } 10^b$		-	110	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	51	-	
Fall Time	t <sub>f</sub>			-	86	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	
Internal Source Inductance	L <sub>S</sub>			-	7.5	-	- nH
Drain-Source Body Diode Characteristic	s	1			I.		<u> </u>
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET sym	MOSFET symbol showing the		-	- 11	- A
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	- 44	
Body Diode Voltage	$V_{SD}$	T <sub>J</sub> = 25 °C, I <sub>S</sub> = - 11 A, V <sub>GS</sub> = 0 V <sup>b</sup>		-	-	- 4.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	- T <sub>J</sub> = 25 °C, I <sub>F</sub> = -19 A, dl/dt = 100 A/μs <sup>b</sup>		-	130	260	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	0.35	0.70	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> and L <sub>D</sub> )					L <sub>D</sub> )

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq$  300  $\mu$ s; duty cycle  $\leq$  2 %.



#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

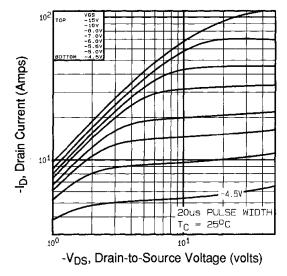


Fig. 1 - Typical Output Characteristics,  $T_C$  = 25 °C

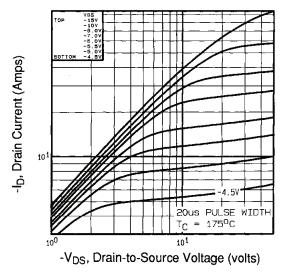


Fig. 2 - Typical Output Characteristics,  $T_C = 175$  °C

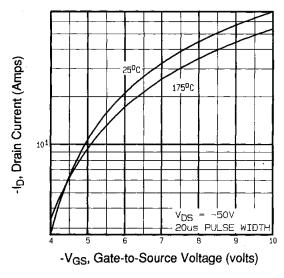


Fig. 3 - Typical Transfer Characteristics

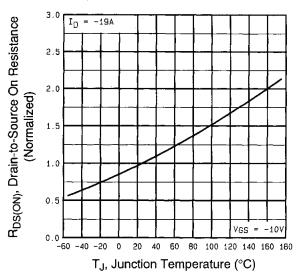


Fig. 4 - Normalized On-Resistance vs. Temperature

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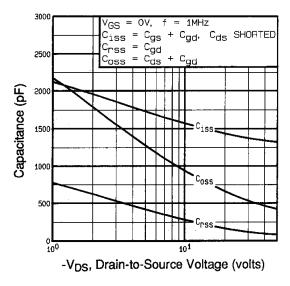


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

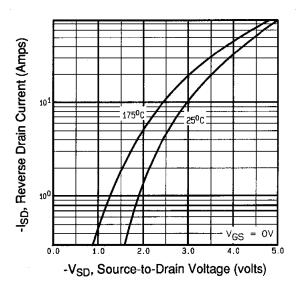


Fig. 7 - Typical Source-Drain Diode Forward Voltage

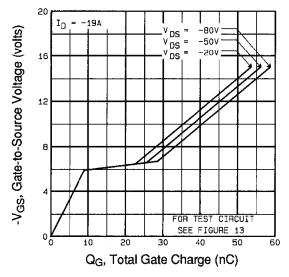


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

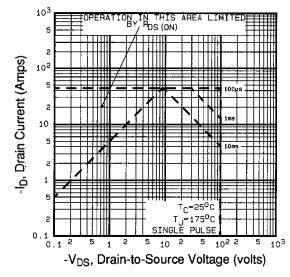


Fig. 8 - Maximum Safe Operating Area



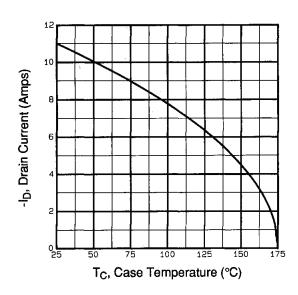


Fig. 9 - Maximum Drain Current vs. Case Temperature

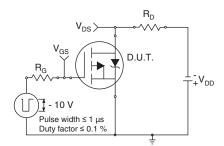


Fig. 10a - Switching Time Test Circuit

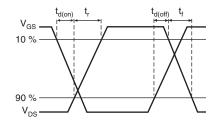


Fig. 10b - Switching Time Waveforms

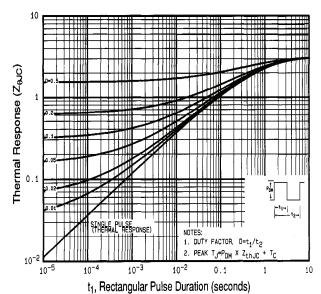


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

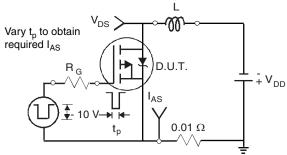


Fig. 12a - Unclamped Inductive Test Circuit

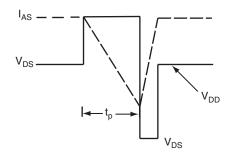
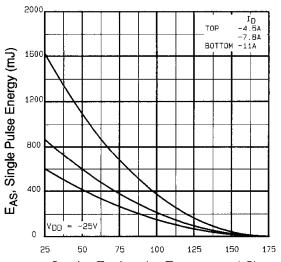


Fig. 12b - Unclamped Inductive Waveforms

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 $Starting \ T_J, \ Junction \ Temperature (^\circ C)$  Fig. 12c - Maximum Avalanche Energy vs. Drain Current

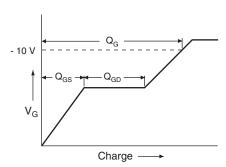


Fig. 13a - Basic Gate Charge Waveform

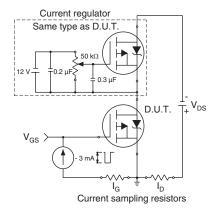
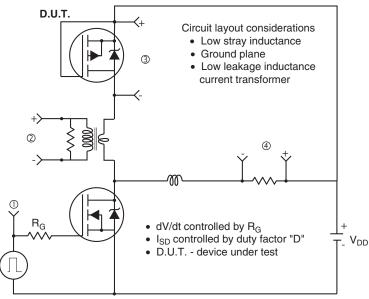


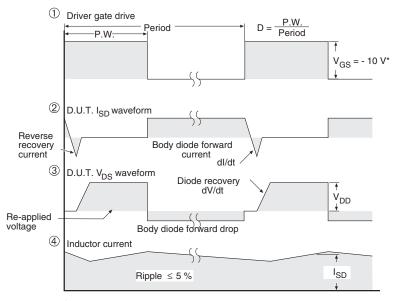
Fig. 13b - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



• Compliment N-Channel of D.U.T. for driver



\*  $V_{GS} = -5$  V for logic level and -3 V drive devices Fig. 14 - For P-Channel

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